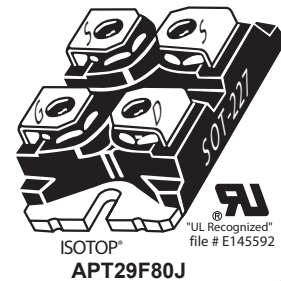
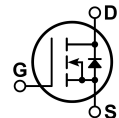


N-Channel FREDFET

POWER MOS 8® is a high speed, high voltage N-channel switch-mode power MOSFET. This 'FREDFET' version has a drain-source (body) diode that has been optimized for high reliability in ZVS phase shifted bridge and other circuits through reduced t_{rr} , soft recovery, and high recovery dv/dt capability. Low gate charge, high gain, and a greatly reduced ratio of C_{rss}/C_{iss} result in excellent noise immunity and low switching loss. The intrinsic gate resistance and capacitance of the poly-silicon gate structure help control di/dt during switching, resulting in low EMI and reliable paralleling, even when switching at very high frequency.



Single die FREDFET



FEATURES

- Fast switching with low EMI
- Low t_{rr} for high reliability
- Ultra low C_{rss} for improved noise immunity
- Low gate charge
- Avalanche energy rated
- RoHS compliant 

TYPICAL APPLICATIONS

- ZVS phase shifted and other full full bridge
- Half bridge
- PFC and other boost converter
- Buck converter
- Single and two switch forward
- Flyback

Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
I_D	Continuous Drain Current @ $T_C = 25^\circ C$	31	A
	Continuous Drain Current @ $T_C = 100^\circ C$	19	
I_{DM}	Pulsed Drain Current ¹	173	
V_{GS}	Gate-Source Voltage	±30	V
E_{AS}	Single Pulse Avalanche Energy ²	1979	mJ
I_{AR}	Avalanche Current, Repetitive or Non-Repetitive	24	A

Thermal and Mechanical Characteristics

Symbol	Characteristic	Min	Typ	Max	Unit
P_D	Total Power Dissipation @ $T_C = 25^\circ C$			543	W
$R_{\theta JC}$	Junction to Case Thermal Resistance			0.23	$^\circ C/W$
$R_{\theta CS}$	Case to Sink Thermal Resistance, Flat, Greased Surface		0.15		
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55		150	$^\circ C$
$V_{Isolation}$	RMS Voltage (50-60Hz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.)	2500			V
W_T	Package Weight		1.03		oz
			29.2		g
Torque	Terminals and Mounting Screws.			10	in·lbf
				1.1	N·m

Static Characteristics

 $T_J = 25^{\circ}\text{C}$ unless otherwise specified

APT29F80J

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$V_{BR(DSS)}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	800			V
$\Delta V_{BR(DSS)}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_D = 250\mu A$		1.41		V/ $^{\circ}\text{C}$
$R_{DS(on)}$	Drain-Source On Resistance ^③	$V_{GS} = 10V, I_D = 24A$		0.19	0.21	Ω
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 2.5mA$	2.5	4	5	V
$\Delta V_{GS(th)}/\Delta T_J$	Threshold Voltage Temperature Coefficient			-10		mV/ $^{\circ}\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 800V$ $V_{GS} = 0V$			250	μA
		$T_J = 25^{\circ}\text{C}$ $T_J = 125^{\circ}\text{C}$			1000	
I_{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 30V$			± 100	nA

Dynamic Characteristics

 $T_J = 25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
g_{fs}	Forward Transconductance	$V_{DS} = 50V, I_D = 24A$		43		S
C_{iss}	Input Capacitance	$V_{GS} = 0V, V_{DS} = 25V$ $f = 1MHz$		9326		pF
C_{rss}	Reverse Transfer Capacitance			159		
C_{oss}	Output Capacitance			927		
$C_{o(cr)}^4$	Effective Output Capacitance, Charge Related	$V_{GS} = 0V, V_{DS} = 0V \text{ to } 533V$		438		
$C_{o(er)}^5$	Effective Output Capacitance, Energy Related			217		
Q_g	Total Gate Charge	$V_{GS} = 0 \text{ to } 10V, I_D = 24A,$ $V_{DS} = 400V$		303		nC
Q_{gs}	Gate-Source Charge			51		
Q_{gd}	Gate-Drain Charge			155		
$t_{d(on)}$	Turn-On Delay Time	Resistive Switching $V_{DD} = 533V, I_D = 24A$ $R_G = 2.2\Omega^{\text{⑥}}, V_{GG} = 15V$		53		ns
t_r	Current Rise Time			76		
$t_{d(off)}$	Turn-Off Delay Time			231		
t_f	Current Fall Time			67		

Source-Drain Diode Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
I_S	Continuous Source Current (Body Diode)	MOSFET symbol showing the integral reverse p-n junction diode (body diode)			31	A
I_{SM}	Pulsed Source Current (Body Diode) ^①				173	
V_{SD}	Diode Forward Voltage	$I_{SD} = 24A, T_J = 25^{\circ}\text{C}, V_{GS} = 0V$			1.2	V
t_{rr}	Reverse Recovery Time	$I_{SD} = 24A^3$ $di_{SD}/dt = 100A/\mu s$	$T_J = 25^{\circ}\text{C}$		370	ns
			$T_J = 125^{\circ}\text{C}$		710	
Q_{rr}	Reverse Recovery Charge		$T_J = 25^{\circ}\text{C}$	1.91		μC
			$T_J = 125^{\circ}\text{C}$	5.18		
I_{rrm}	Reverse Recovery Current		$T_J = 25^{\circ}\text{C}$	12		A
			$T_J = 125^{\circ}\text{C}$	18		
dv/dt	Peak Recovery dv/dt	$I_{SD} \leq 24A, di/dt \leq 1000A/\mu s, V_{DD} = 100V,$ $T_J = 125^{\circ}\text{C}$			25	V/ns

① Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

② Starting at $T_J = 25^{\circ}\text{C}$, $L = 6.9mH$, $R_G = 25\Omega$, $I_{AS} = 24A$.③ Pulse test: Pulse Width $< 380\mu s$, duty cycle $< 2\%$.④ $C_{o(cr)}$ is defined as a fixed capacitance with the same stored charge as C_{OSS} with $V_{DS} = 67\%$ of $V_{(BR)DSS}$.⑤ $C_{o(er)}$ is defined as a fixed capacitance with the same stored energy as C_{OSS} with $V_{DS} = 67\%$ of $V_{(BR)DSS}$. To calculate $C_{o(er)}$ for any value of V_{DS} less than $V_{(BR)DSS}$, use this equation: $C_{o(er)} = -8.27E-7/V_{DS}^2 + 1.01E-7/V_{DS} + 1.43E-10$.⑥ R_G is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

Typical Performance Curves

APT29F80J

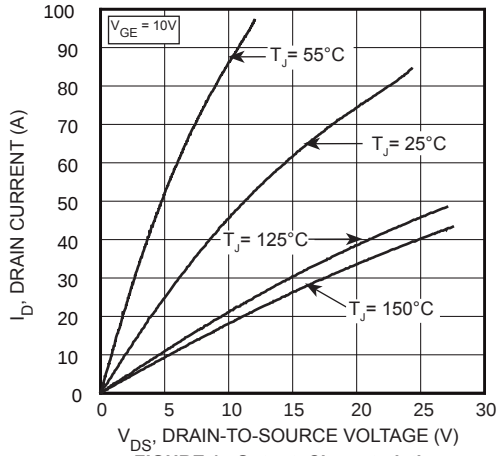


FIGURE 1, Output Characteristics

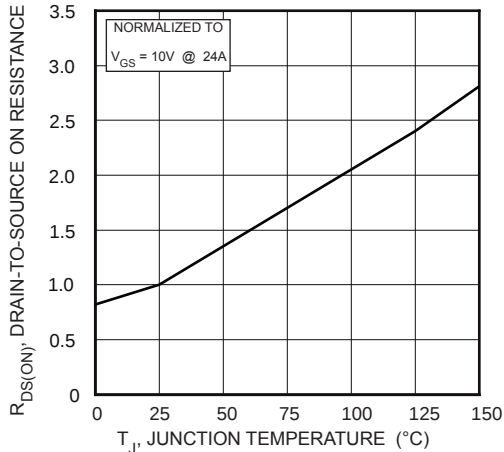


FIGURE 3, $R_{DS(ON)}$ vs Junction Temperature

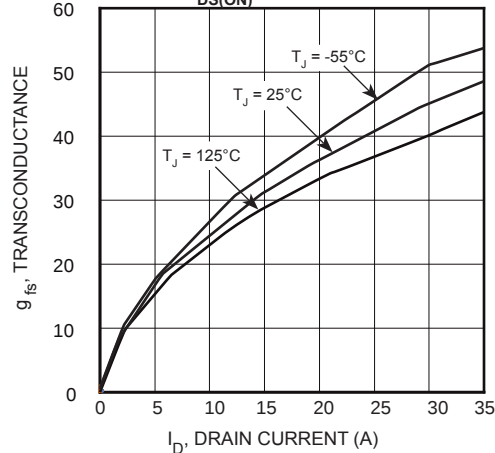


FIGURE 5, Gain vs Drain Current

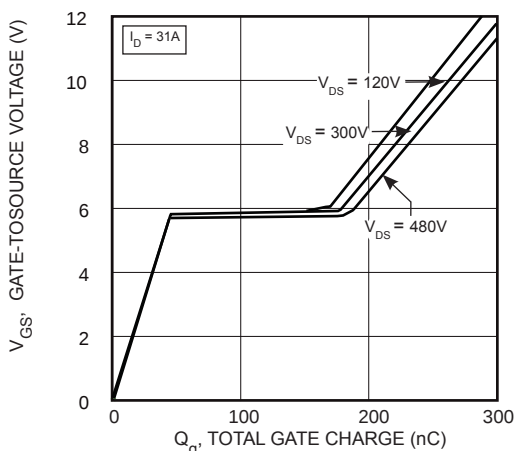


FIGURE 7, Gate Charge vs Gate-to-Source Voltage

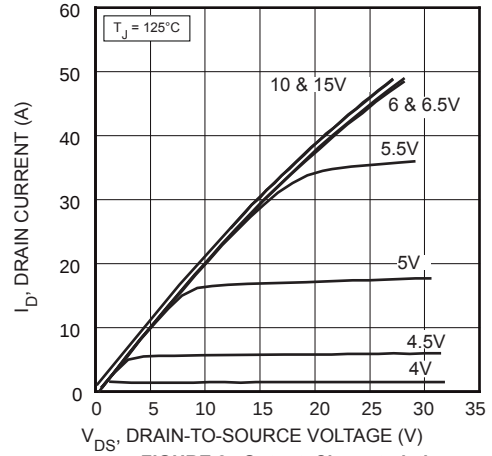


FIGURE 2, Output Characteristics

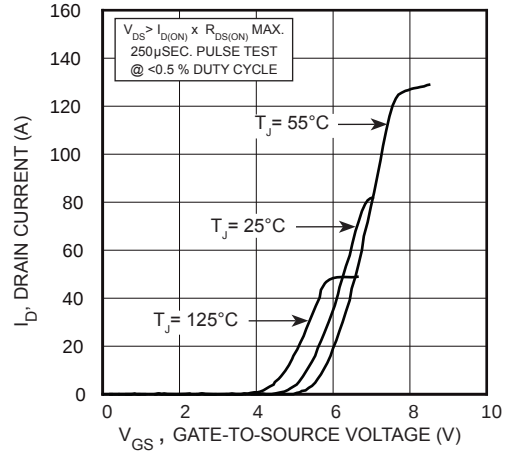


FIGURE 4, Transfer Characteristics

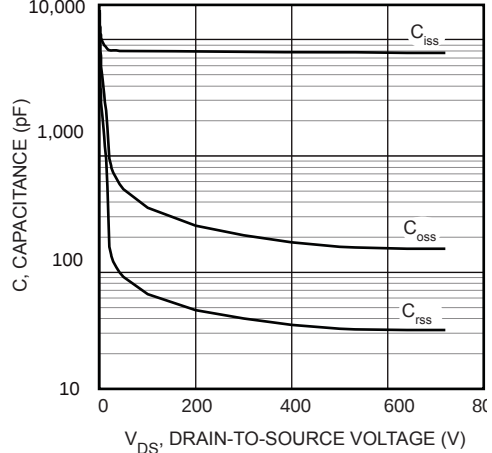


FIGURE 6, CAPACITANCE VS DRAIN-TO-SOURCE VOLTAGE

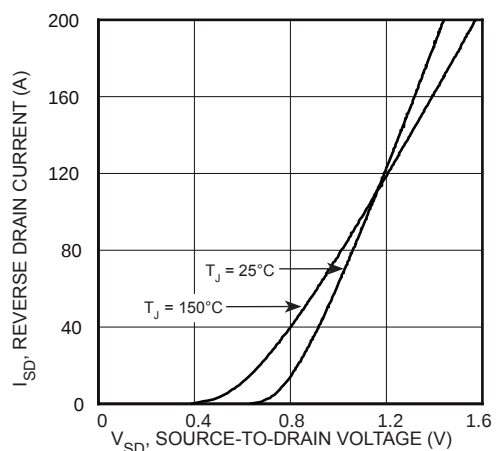
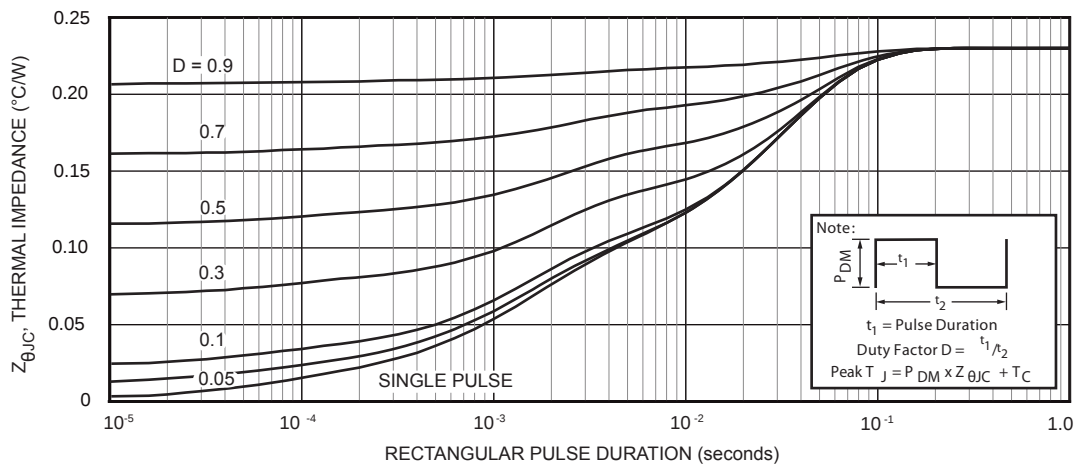
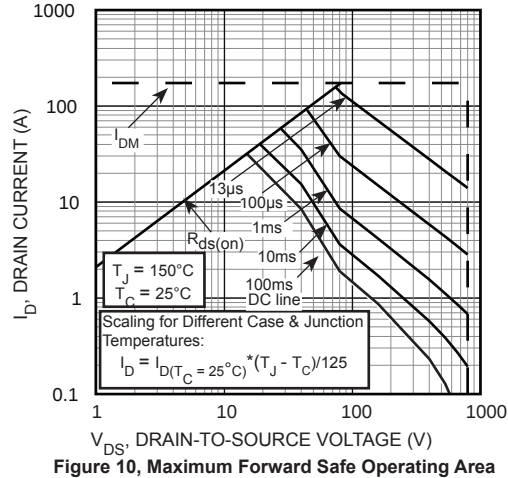
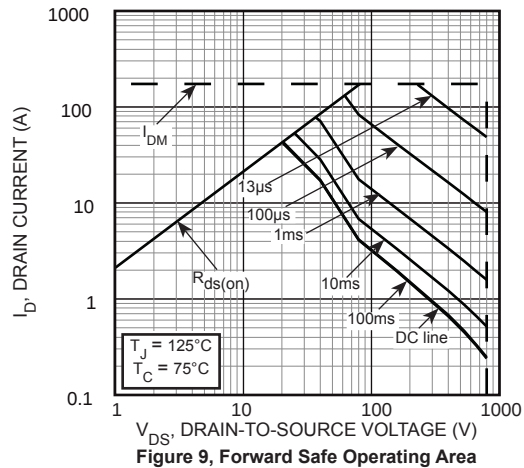
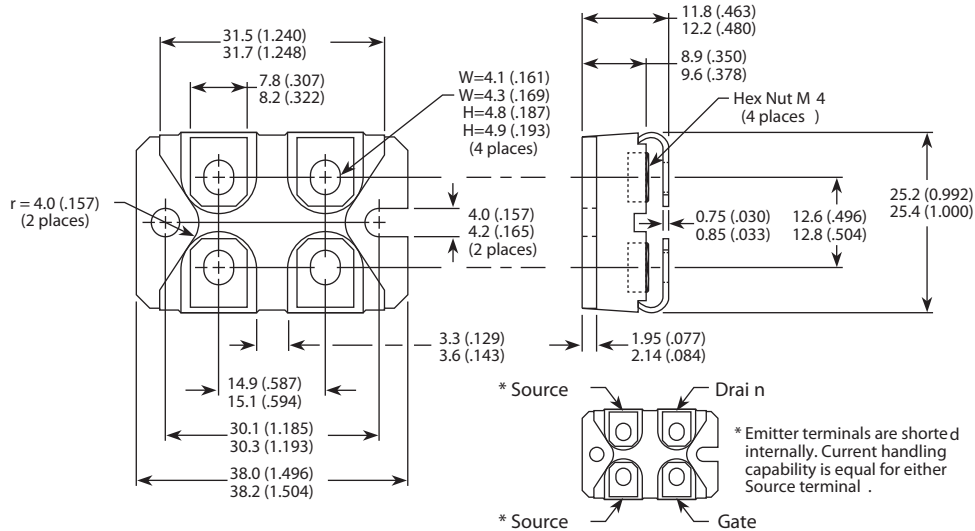


FIGURE 8, Reverse Drain Current vs Source-to-Drain Voltage



SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)